

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Tsung-Shih Lee	10/15/2009
RECEIVING PARTY DATA	
Name:	Cheng Uei Precision Industry Co., Ltd.
Street Address:	No. 18, Chung Shan Road, Tu Cheng City
City:	Taipei
State/Country:	TAIWAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12580411
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NAME OF SUBMITTER:	Anthony King
Total Attachments: 1 source=983733-IE-assignment#page1.tif	

OP \$40.00 12580411

ASSIGNMENT BY INVENTOR(S) OF U.S. APPLICATION

WHEREAS, I am the original, first and sole inventor and I own (if only one name is listed below) or an original, first and joint inventor and the joint inventors own (if plural names are listed below) (referred to as "ASSIGNOR" below) the subject matter which is claimed and for which a patent is sought on the invention (referred to as the "INVENTION" below) entitled:

Title: RECEPTACLE

the specification of which (check one):

- is executed on even date herewith.
- was filed on _____ as U.S. Application Number
- was filed on _____ as PCT Application Number
- was executed on the following date(s) _____

WHEREAS, **Cheng Uei Precision Industry Co., Ltd.**

having a postal address of **No. 18, Chung Shan Road, Tu Cheng City, Taipei, Taiwan, R.O.C.**

(referred to as "ASSIGNEE" below) desires to acquire the entire right, title and interest in and to the same in the U.S.;

NOW, THEREFORE, for good and valuable consideration, the receipt and adequacy of which is hereby acknowledged, ASSIGNOR, by these presents does sell, assign and transfer unto ASSIGNEE, the entire right, title, and interest in and to said INVENTION and application throughout the United States of America, including any and all patents granted on any division, continuation, continuation-in-part and reissue of said application.

ALSO, ASSIGNOR hereby agrees to execute any documents that legally may be required in connection with the filing, prosecution and maintenance of said application or any other patent applications in the United States for said INVENTION, including additional documents that may be required to affirm the rights of ASSIGNEE in and to said INVENTION, all without further consideration. ASSIGNOR also agrees, without further consideration and at ASSIGNEE's expense, to identify and communicate to ASSIGNEE at ASSIGNEE's request documents and information concerning the INVENTION that are within ASSIGNOR's possession or control, and to provide further assurances and testimony on behalf of ASSIGNEE that lawfully may be required of ASSIGNOR in respect of the prosecution, maintenance and defense of any patent application or patent encompassed within the terms of this instrument. ASSIGNOR's obligations under this instrument shall extend to ASSIGNOR's heirs, executors, administrators and other legal representatives.

ALSO, ASSIGNOR hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all patents referred to above to ASSIGNEE, as the ASSIGNEE of the entire right, title and interest in and to the same, for ASSIGNEE's sole use and behoof; and for the use and behoof of ASSIGNEE's legal representatives and successors, to the full end of the term for which such patent may be granted, as fully and entirely as the same would have been held by ASSIGNOR had this assignment and sale not been made.

Full Name of First or Sole Inventor Lee, Tsung-Shih	Post Office Address: No. 18, Chung Shan Road, Tu Cheng City, Taipei, Taiwan, R.O.C.
Citizenship Taiwan, R. O. C.	Residence : No. 18, Chung Shan Road, Tu Cheng City, Taipei, Taiwan, R.O.C.
Date October 15, 2009	Signature LEE, TSUNG-SHIH

Full Name of Second or Sole Inventor	Post Office Address:
Citizenship	Residence :
Date	Signature

See following page(s) for additional joint inventors.

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